

P-Ch 30V Fast Switching MOSFETs

- ★ Green Device Available
- ★ Super Low Gate Charge
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

Product Summary



BVDSS	RDSON	ID
-30V	48mΩ	-4A

Description

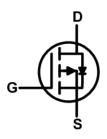
The XR3401 is the high cell density trenched P-ch MOSFETs, which provides excellent RDSON and efficiency for most of the small power switching and load switch applications.

The XR3401 meet the RoHS and Green Product

requirement with full function reliability approved.

SOT23 Pin Configuration





Absolute Maximum Ratings (@ T_A = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		-30	V
V_{GS}	Gate-to-Source Voltage		±12	V
I _D	Continuous Drain Current	T _A = 25°C	-4	Α
		T _A = 100°C	-3	A
I _{DM}	Pulsed Drain Current (1)		-16	А
P_{D}	Power Dissipation	T _A = 25°C	1.2	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient ⁽²⁾		108	°C/W
T_{J} , T_{STG}	Junction & Storage Temperature Range		-55 to 150	°C



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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Cha	aracteristics			•	•	
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = -250 \mu A, V_{GS} = 0 V$	-30	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -30V, V_{GS} = 0V$	-	-	1.0	μА
I_{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 12V$	-	-	±100	nA
On Cha	aracteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-0.6	-0.95	-1.3	V
	Static Drain-Source ON-Resistance ⁽³⁾	$V_{GS} = -10V, I_{D} = -4A$	-	48	62	mΩ
R _{DS(ON)}		$V_{GS} = -4.5V, I_D = -3A$	-	56	73	mΩ
		$V_{GS} = -2.5V, I_D = -3A$	-	75	98	mΩ
Dynam	ic Characteristics			_		
C _{iss}	Input Capacitance		_	553	-	pF
C _{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = -15V,$ f = 1MHz	-	57	-	pF
C _{rss}	Reverse Transfer Capacitance	1 – 11/11/12	-	35	-	pF
Qg	Total Gate Charge		-	6.5	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to } -4.5V$ $V_{DS} = -15V, I_D = -3A$	-	1.4	-	nC
Q_{gd}	Gate Drain("Miller") Charge	_ v _{DS} = -10 v, 1 _D = -0/(-	1.7	-	nC
Switch	ing Characteristics				1	
$t_{d(on)}$	Turn-On DelayTime	_	-	10	-	ns
t _r	Turn-On Rise Time	$V_{GS} = -4.5V, V_{DD} = -15V$	-	86	-	ns
t _{d(off)}	Turn-Off DelayTime	I_D = -3A, R_{GEN} = 3Ω	-	150	-	ns
t _f	Turn-Off Fall Time		-	357	-	ns
Drain-S	Source Diode Characteristics and N	lax Ratings				
Is	Maximum Continuous Drain to Source Diode Forward Current			-	-4	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Fo	rward Current	-		-16	Α
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{S} = -4A$	-	-	-1.2	V
trr	Body Diode Reverse Recovery Time	I _F = -3A, di/dt = 80A/us	-	36	-	ns
Qrr	Body Diode Reverse Recovery Charge	- IF3A, UI/UI - OUA/US	-	5	-	nC

Notes:

- 1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.
- 2. R_{BJA} is measured with the device mounted on a 1inch² pad of 2oz copper FR4 PCB
- 3. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.



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Typical Performance Characteristics

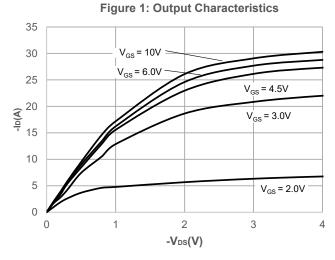


Figure 2: Typical Transfer Characteristics

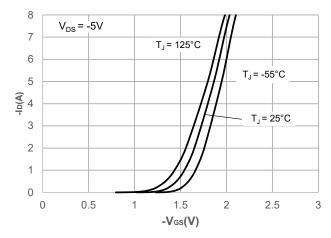


Figure 3: On-resistance vs. Drain Current

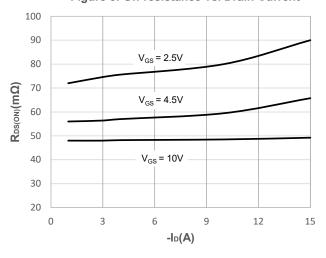


Figure 4: Body Diode Characteristics

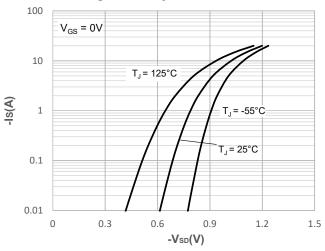


Figure 5: Gate Charge Characteristics

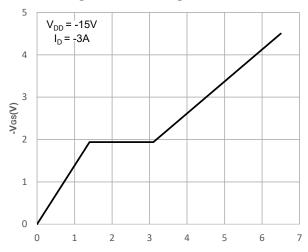
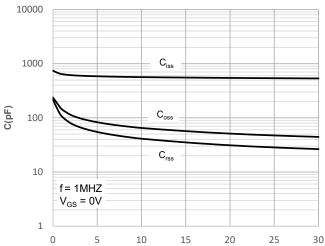


Figure 6: Capacitance Characteristics





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Typical Performance Characteristics

Figure 7: Normalized Breakdown voltage vs. Junction Temperature

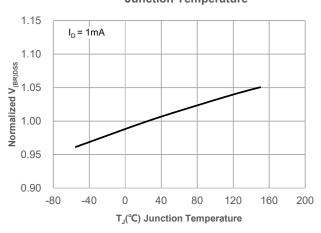


Figure 9: Maximum Safe Operating Area

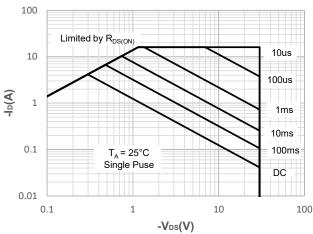


Figure 11: Normalized Maximum Transient Thermal Impedance

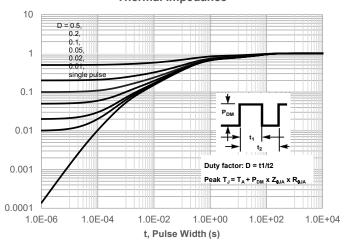


Figure 8: Normalized on Resistance vs. Junction Temperature

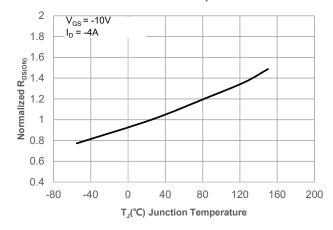


Figure 10: Maximum Continuous Drian Current vs. Ambient Temperature

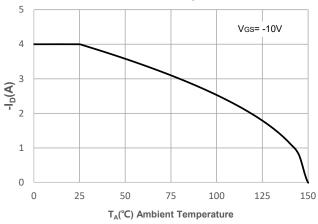
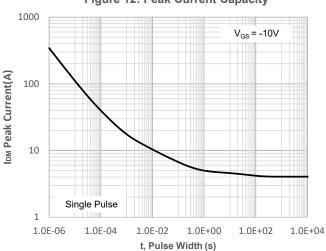


Figure 12: Peak Current Capacity





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Test Circuit

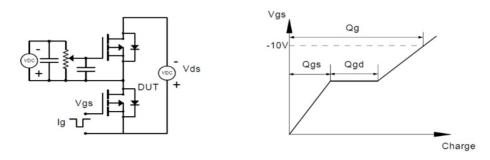


Figure 1: Gate Charge Test Circuit & Waveform

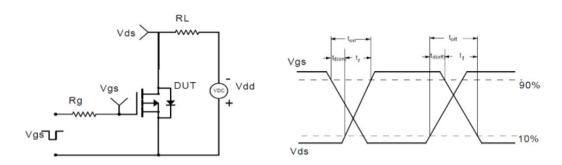


Figure 2: Resistive Switching Test Circuit & Waveform

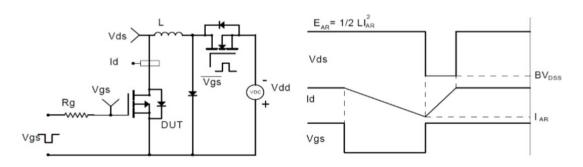


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

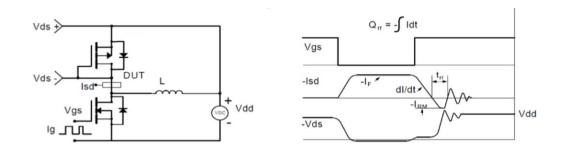
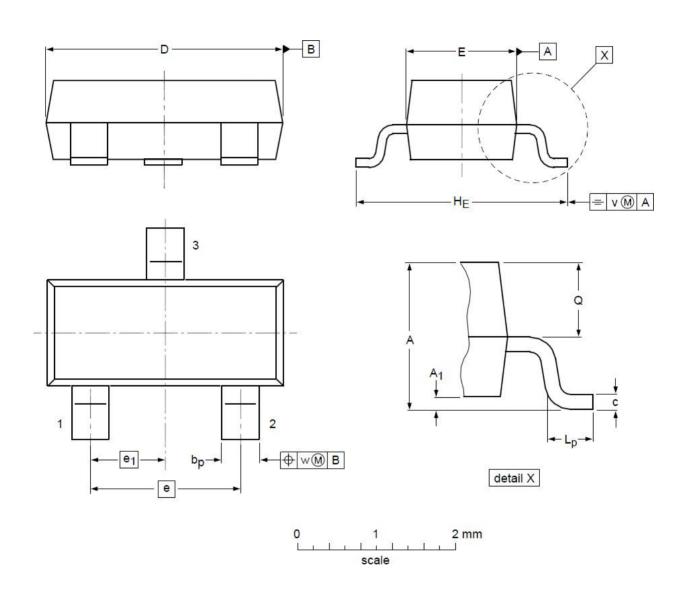


Figure 4: Diode Recovery Test Circuit & Waveform



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Package Mechanical Data-SOT-23



DIMENSIONS (unit : mm)

Symbol	Min	Тур	Max	Symbol	Min	Тур	Max
Α	0.90	1.01	1.15	A ₁	0.01	0.05	0.10
b _p	0.30	0.42	0.50	С	0.08	0.13	0.15
D	2.80	2.92	3.00	E	1.20	1.33	1.40
е		1.90		e ₁		0.95	
HE	2.25	2.40	2.55	Lp	0.30	0.42	0.50
Q	0.45	0.49	0.55	v		0.20	
w		0.10					